533268-7 - ACTIVE

AMP-HDI

TE Internal #: 533268-7 PCB Mount Receptacle, Right Angle, Board-to-Board, 150 Position, . 1 in [2.54 mm] Centerline, Gold, Through Hole - Solder, Signal, Black

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PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Right Angle

Connector System: Board-to-Board

Number of Positions: 150

Number of Rows: 3

Features



Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	No
PCB Mount Orientation	Right Angle
Number of Positions	150
Number of Rows	3
Electrical Characteristics	
Insulation Resistance	3 MΩ
Body Features	
Primary Product Color	Black

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Contact Features

Operation/Application	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Housing Temperature Rating	High
Jsage Conditions	
PCB Thickness (Recommended)	2.36 mm[.76 in]
Connector Height	9.14 mm[.36 in]
Dimensions	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Housing Features	
Connector Mounting Type	Board Mount
PCB Mount Alignment	Without
PCB Mount Retention	Without
Mating Alignment Type	Keyed
Mating Alignment	Without
PCB Mount Retention Type	Mounting Hole
Mechanical Attachment	
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Post & Tail Length	3.05 mm[.12 in]
Rectangular Termination Post & Tail Width	.58 mm[.023 in]
Rectangular Termination Post & Tail Thickness	.25 mm[.01 in]
Termination Features	
Contact Current Rating (Max)	3 A
Contact Type	Socket
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Shape & Form	Four Beam
Mating Square Post Dimension	.64 mm[.025 in]
Contact Layout	Matrix

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Assembly Process Feature	None
Circuit Application	Signal
ndustry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	4
Packaging Type	Tube
EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	
EU REACH Regulation (EC) No. 1907/2006	Restricted Materials Above Threshold
	Current ECHA Candidate List: JUNE 2022
	Current ECHA Candidate List: JUNE 2022 (224)
	Current ECHA Candidate List: JUNE 2022 (224)
	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUL 2021 (219) SVHC > Threshold:
	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUL 2021 (219)

handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content

BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.

Not lead free process capable

Product Compliance Disclaimer

Solder Process Capability

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

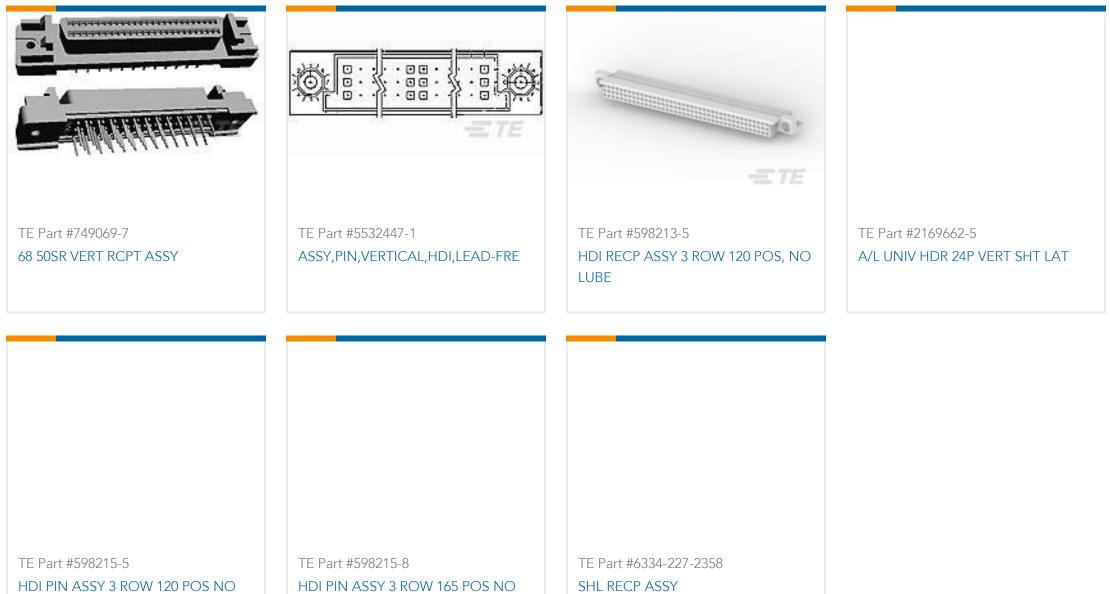
Compatible Parts

PCB Mount Receptacle, Right Angle, Board-to-Board, 150 Position, .1 in [2.54 mm] Centerline, Gold, Through Hole - Solder, Signal, Black





Customers Also Bought



HDI PIN ASSY 3 ROW 120 POS NO	
LUBE	

Documents

Product Drawings HDI RECP ASSY 3 ROW 150 POS

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_533268-7_R.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_533268-7_R.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_533268-7_R.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

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Datasheets & Catalog Pages

1-1773957-5_AMP_HDI_BTB_CONNECTORS_EN

English

Product Specifications

Application Specification

English

Product Environmental Compliance

Product Compliance

English

Product Compliance

English

Instruction Sheets

Instruction Sheet (U.S.)

English